



DSC21XX/DSC22XX

Programming User's Guide

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NOTES:

Preface

NOTICE TO CUSTOMERS

All documentation becomes dated, and this manual is no exception. Microchip tools and documentation are constantly evolving to meet customer needs, so some actual dialogs and/or tool descriptions may differ from those in this document. Please refer to our web site (www.microchip.com) to obtain the latest documentation available.

Documents are identified with a “DS” number. This number is located on the bottom of each page, in front of the page number. The numbering convention for the DS number is “DSXXXXXXA”, where “XXXXXX” is the document number and “A” is the revision level of the document.

For the most up-to-date information on development tools, see the MPLAB® IDE online help. Select the Help menu, and then Topics to open a list of available online help files.

INTRODUCTION

This chapter contains general information that will be useful to know before using the DSC22XX/DSC21XX Programming Guide. Items discussed in this chapter include:

- [Document Layout](#)
- [Conventions Used in this Guide](#)
- [The Microchip Website](#)
- [Customer Support](#)
- [Document Revision History](#)

DOCUMENT LAYOUT

This document describes how to use the DSC22XX/DSC21XX Programming Guide to program a MEMS oscillator device. The manual layout is as follows:

- **Chapter 1. “Product Overview”** – Provides important information about the DSC22XX/DSC21XX Programming Guide.
- **Chapter 2. “Programming Features”** – Provides information about using the DSC22XX/DSC21XX Programming Guide.

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CONVENTIONS USED IN THIS GUIDE

This manual uses the following documentation conventions:

DOCUMENTATION CONVENTIONS

Description	Represents	Examples
Arial font:		
Italic characters	Referenced books	<i>MPLAB® IDE User's Guide</i>
	Emphasized text	...is the <i>only</i> compiler...
Initial caps	A window	the Output window
	A dialog	the Settings dialog
	A menu selection	select Enable Programmer
Quotes	A field name in a window or dialog	"Save project before build"
Underlined, italic text with right angle bracket	A menu path	<u><i>File>Save</i></u>
Bold characters	A dialog button	Click OK
	A tab	Click the Power tab
N'Rnnnn	A number in verilog format, where N is the total number of digits, R is the radix and n is a digit.	4'b0010, 2'hF1
Text in angle brackets < >	A key on the keyboard	Press <Enter>, <F1>
Courier New font:		
Plain Courier New	Sample source code	#define START
	Filenames	autoexec.bat
	File paths	c:\mcc18\h
	Keywords	_asm, _endasm, static
	Command-line options	-Opa+, -Opa-
	Bit values	0, 1
	Constants	0xFF, 'A'
Italic Courier New	A variable argument	<i>file.o</i> , where <i>file</i> can be any valid filename
Square brackets []	Optional arguments	mcc18 [options] <i>file</i> [options]
Curly brackets and pipe character: { }	Choice of mutually exclusive arguments; an OR selection	errorlevel {0 1}
Ellipses...	Replaces repeated text	var_name [, var_name...]
	Represents code supplied by user	void main (void) { ... }

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- Technical Support

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Technical support is available through the web site at: <http://support.microchip.com>.

DOCUMENT REVISION HISTORY

Revision A (April 2018)

- Converted Micrel version of the DSC22XX/DSC21XX Programming Guide to Microchip User Guide DS50002739A.

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NOTES:

Chapter 1. Product Overview

1.1 DEVICE ARCHITECTURE

The DSC21XX & DSC22XX families of low jitter, configurable single and dual output oscillators consist of a MEMS resonator and a high performance PLL IC, programmable via I²C/SPI interface. This document will explain how to program the output frequencies as well as the CMOS outputs drive strength.

The basic block diagram of the dual and single output oscillators including the integrated PLL and clock distribution path are shown in [Figure 1-1](#) and [Figure 1-2](#). These oscillators are equipped with a high performance fractional-N PLL that locks an integrated high frequency VCO to the internal MEMS oscillator. The output of the VCO is then divided down through independent even integer dividers, with divide values ranging from 4 to 254, to generate the desired output clock frequencies. Each clock output is buffered by a low-noise output driver, available in CMOS, LVPECL, LVDS, and HCSL formats.

Block Diagrams of Single and Dual Output DSC20XX Oscillators

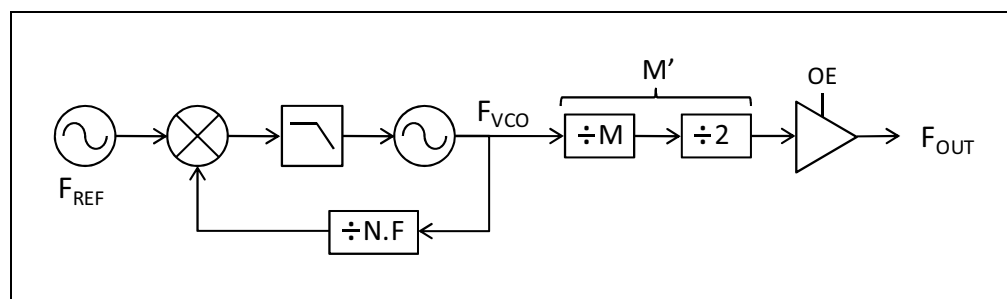


FIGURE 1-1: Single Output Oscillator.

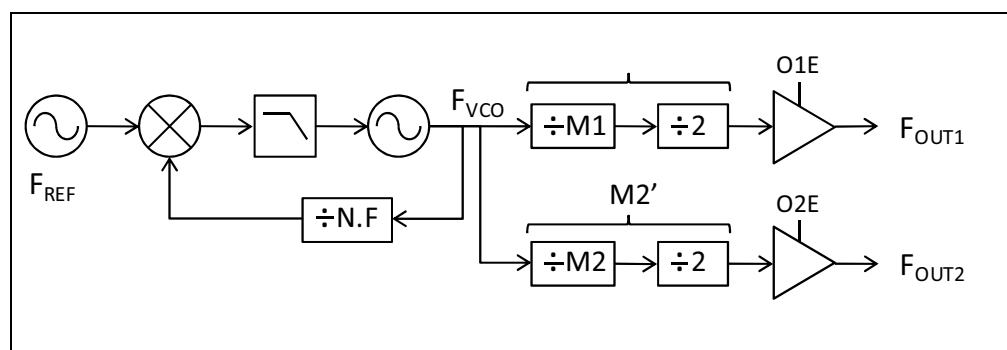


FIGURE 1-2: Dual Output Oscillator.

1.2 DEFAULT CONDITIONS

Upon power-up, the initial output frequency configuration is controlled by an internal preprogrammed memory (OTP). This memory stores all coefficients required by the PLL for two independent default frequencies for a single output oscillator, or two fre-

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quency combinations for a dual output version. The control pin (FS) selects which default frequency is the initial setting. After power-up, a new output frequency configuration can be programmed using I²C/SPI interface.

The CMOS output drive strength, which is programmable using 3 control bits, is set by default to maximum strength or the value of 111. After power-up, a new CMOS drive-strength setting can be programmed using I²C/SPI interface.

Chapter 2. Programming Features

2.1 PROGRAMMING CLOCK FREQUENCIES

This section describes the PLL variables and registers used to configure the oscillator to produce the desired output frequencies.

As shown in [Figure 1-1](#) and [Figure 1-2](#), several parameters need to be programmed to determine the internal VCO and the output clock frequencies. The PLL consists of a feedback divider with a fractional value described as N.F, where N (7-bit value) and F (17-bit value) are the integer and fractional portions of the divider value, respectively. The PLL is then followed by M divider (8-bit value) integer divider and a final divide-by-2 stage to ensure 50% output clock duty cycle. The combination of these two dividers creates an even integer M' divider block with divider value range of 4 to 254. It must be noted that M must have a minimum value of 2. To summarize, the output frequency is specified by three programmable values, N, F & M.

2.1.1 Calculation of N,F & M for Single-Output Oscillator (DSC21X0 & DSC22X0)

To optimize performance of the PLL, it is desirable to program the internal PLL to the lowest possible valid VCO frequency that can generate the desired output clock frequency. The minimum valid VCO frequency for the device is 1135 MHz while the optimum VCO frequency range is from 1175 to 1700 MHz. Below is an example illustrating how to calculate the required N, F & M values.

Example:

Desired Clock Frequency: $F_{OUT} = 25 \text{ MHz}$

Lowest Optimum VCO Frequency: $F_{VCO} = F_{OUT} \times M' = 25 \times 48 = 1200 \text{ MHz}$

$M = M' \div 2 = 24$

Once the VCO frequency is determined, the N.F value can be easily calculated by dividing the VCO frequency by the input reference frequency from the MEMS oscillator, which is calibrated in the fabrication process to 18 MHz.

$N.F = F_{VCO} \div F_{REF} = 1200 \text{ MHz} \div 18 \text{ MHz} = 66.666667$

$N = 66, F = 0.666667$

Since F is described using a 17-bit register, we need to calculate it as the numerator value that will create our desired fraction with $(2^{17} - 1)$ in the denominator. This number will then need to be rounded to the nearest integer value.

$F [16:0] = 0.666667 \times (2^{17} - 1) = 87380.71 \rightarrow F [16:0] = 87381 \text{ (rounded)}$

The final step before programming the values into the appropriate registers is to convert M, N, and F to the appropriate binary or hexadecimal values.

$M [7:0] = 24_{dec} = 0001 \ 1000 \text{ bin} = 18_{hex}$

$N [6:0] = 66_{dec} = 1000 \ 0101 \text{ bin} = 85_{hex}$

$F [16:0] = 87381_{dec} = 1 \ 0101 \ 0101 \ 0101 \ 0101 \text{ bin} = 15555_{hex}$

We now load the resulting values into the appropriate registers to program the DSC21X0 or DSC22X0 to the desired output clock frequency. [Table 2-1](#) describes the register map for the variables described above.

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TABLE 2-1: REGISTER MAP FOR THE SINGLE-OUTPUT DSC2XXX OSCILLATOR

Register	7	6	5	4	3	2	1	0
0x13	F[7]	F[6]	F[5]	F[4]	F[3]	F[2]	F[1]	F[0]
0x14	F[15]	F[14]	F[13]	F[12]	F[11]	F[10]	F[9]	F[8]
0x15	N[6]	N[5]	N[4]	N[3]	N[2]	N[1]	N[0]	N[16]
0x16	M1[7]	M1[6]	M1[5]	M1[4]	M1[3]	M1[2]	M1[1]	M1[0]

Note: In reference to Register 0x13: Register 0x13 holds the least eight significant bits of the 17-bit F value. This register, though, is not accessible through the I²C and no writes should be made to it. While some frequency granularity is lost in programming only the upper 8 bits of F, frequency steps of about 13 ppm can be achieved, sufficiently fine for most applications.

Commonly used clock frequencies:

Table 2-2 provides a list of commonly used output clock frequencies, corresponding PLL variables, and register parameters that need to be programmed into the oscillator via I²C/SPI interface.

TABLE 2-2: COMMON CLOCK FREQUENCIES AND CORRESPONDING PARAMETERS

Freq (MHz)	M	N	F	FVCO (MHz)	Registers (address & value in HEX)			
					0x13	0x14	0x15	0x16
19.2	31	66	0.133333	1190.4000	44	44	84	1F
24	25	66	0.666667	1200.0000	55	55	85	19
25	24	66	0.666667	1200.0000	55	55	85	18
33.3333	18	66	0.666666	1200.0000	55	55	85	12
40	15	66	0.666667	1200.0000	55	55	85	15
48	13	69	0.333333	1248.0000	AA	AA	8A	0D
50	12	66	0.666667	1200.0000	55	55	85	0C
54	11	66	0	1188.0000	00	00	84	0B
62.5	10	69	0.444444	1250.0000	8E	E3	8A	0A
66.6666	9	66	0.666666	1200.0000	55	55	85	09
74.25	8	66	0	1188.0000	00	00	84	08
75	8	66	0.666667	1200.0000	55	55	85	08
77.76	8	69	0.12	1244.1600	71	3D	8A	08
100	6	66	0.666667	1200.0000	55	55	85	06
106.25	6	70	0.833333	1275.0000	AA	AA	8D	06
125	5	69	0.444444	1250.0000	8E	E3	8A	05
133.333	5	74	0.074074	1333.3333	ED	25	94	05
148.5	4	66	0	1188.0000	00	00	84	04
150	4	66	0.666667	1200.0000	55	55	85	04
155.52	4	69	0.12	1244.1600	71	3D	8A	04
156.25	4	69	0.444444	1250.0000	8E	E3	8A	04
200	3	66	0.666667	1200.0000	55	55	85	03
212.5	3	70	0.833333	1275.0000	AA	AA	8D	03
400	2	88	0.888889	1600.0000	1C	C7	B1	02

2.1.2 Calculation of N, F & M for Dual-Output Oscillator (DSC21XX & DSC22XX)

Calculation of the PLL parameters (N, F & M) for the dual output oscillator devices is very similar to that described in the previous section. However, the oscillator will now need to simultaneously generate two output clock frequencies from a single VCO frequency. This constraint alters the computation of the common VCO frequency. We need a valid VCO frequency that when divided by two independent even integer values, each ranging from 4 to 254, will generate both desired output clock frequencies. This analysis is best performed with an iterative approach using a spreadsheet.

Example:

Desired Clock Frequency 1: $F_{OUT1} = 125 \text{ MHz}$

Desired Clock Frequency 2: $F_{OUT2} = 25 \text{ MHz}$

Lowest Common VCO Frequency (from spreadsheet): $F_{VCO} = 1250 \text{ MHz}$

Once the VCO frequency is determined, all other parameters can be easily calculated as shown in previous section.

Example:

$$M1' = F_{VCO} \div F_{OUT1} = 1250 \text{ MHz} \div 125 \text{ MHz} = 10$$

$$M1 = M1' \div 2 = 5$$

And

$$M2' = F_{VCO} \div F_{OUT2} = 1250 \text{ MHz} \div 25 \text{ MHz} = 50$$

$$M2 = M2' \div 2 = 25$$

$$N.F = F_{VCO} \div F_{REF} = 1250 \text{ MHz} \div 18 \text{ MHz} = 69.444444$$

$$N = 69, F = 0.444444$$

Since F is described using a 17-bit register, we need to calculate it as the numerator value that will create our desired fraction with $(2^{17} - 1)$ as the denominator. This number will then need to be rounded to the nearest integer value.

$$F [16:0] = 0.444444 \times (2^{17} - 1) = 58253.71 \rightarrow F [16:0] = 58254 \text{ (rounded)}$$

The final step before programming the values into the appropriate registers is to convert the M, N, and F to the appropriate binary or hexadecimal values.

$$M1 [7:0] = 5_{\text{dec}} = 0000 0101_{\text{bin}} = 05_{\text{hex}}$$

$$M2 [7:0] = 25_{\text{dec}} = 0001 1001_{\text{bin}} = 19_{\text{hex}}$$

$$N [6:0] = 69_{\text{dec}} = 1000 1010_{\text{bin}} = 8A_{\text{hex}}$$

$$F [16:0] = 58254_{\text{dec}} = 0 1110 0011 1000 1110_{\text{bin}} = 0E38E_{\text{hex}}$$

We now load the resulting values into the appropriate registers to program the DSC21XX or DSC22XX to our desired output clock frequencies. [Table 2-3](#) describes the register map for the variable described above.

TABLE 2-3: REGISTER MAP FOR THE DUAL-OUTPUT DSC21XX & DSC22XX OSCILLATORS

Register	7	6	5	4	3	2	1	0
0x13	F[7]	F[6]	F[5]	F[4]	F[3]	F[2]	F[1]	F[0]
0x14	F[15]	F[14]	F[13]	F[12]	F[11]	F[10]	F[9]	F[8]
0x15	N[6]	N[5]	N[4]	N[3]	N[2]	N[1]	N[0]	N[16]
0x16	M1[7]	M1[6]	M1[5]	M1[4]	M1[3]	M1[2]	M1[1]	M1[0]
0x17	M2[7]	M2[6]	M2[5]	M2[4]	M2[3]	M2[2]	M2[1]	M2[0]

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Note: In reference to Register 0x13: Register 0x13 holds the least eight significant bits of the 17-bit F value. This register, though, is not accessible through the I²C and no writes should be made to it. While some frequency granularity is lost in programming only the upper 8 bits of F, frequency steps of about 13 ppm can be achieved, sufficiently fine for most applications.

Commonly used clock frequencies:

Table 4 provides a list of commonly used output clock frequency combinations, corresponding PLL variables, and register values that need to be programmed into the oscillator via I²C/SPI interface.

Contact factory for frequency pairs not included in the table below.

TABLE 2-4: COMMON CLOCK FREQUENCY PAIRS AND CORRESPONDING PARAMETERS

Freq1 (MHz)	Freq2 (MHz)	M1	M2	N	F	FVCO (MHz)	Registers (address & value in HEX)				
							0x13	0x14	0x15	0x16	0x17
27	24	24	27	72	0	1296.0000	00	00	90	18	1B
27	25	25	27	75	0	1350.0000	00	00	96	19	1B
33.3333	25	18	24	66	0.66666	1199.0000	54	55	85	12	18
40	25	15	24	66	0.66667	1200.0000	55	55	85	0F	18
50	25	12	24	66	0.66667	1200.0000	55	55	85	0C	18
75	25	8	24	66	0.66667	1200.0000	55	55	85	08	18
100	25	6	24	66	0.66667	1200.0000	55	55	85	06	18
106.25	25	8	34	94	0.44444	1700.0000	8E	E3	BC	08	22
125	25	5	25	69	0.44444	1250.0000	8E	E3	8A	05	19
150	25	4	24	66	0.66667	1200.0000	55	55	85	04	18
156.25	25	4	25	69	0.44444	1250.0000	8E	E3	8A	04	19
212.5	25	4	34	94	0.44444	1700.0000	8E	E3	BC	04	22
40	33.3333	20	24	88	0.88889	1600.0000	1C	C7	B1	14	18
48	40	15	18	80	0	1440.0000	00	00	A0	0F	12
100	75	6	8	66	0.66667	1200.0000	55	55	85	06	08
50	106.25	17	8	94	0.44444	1700.0000	8E	E3	BC	11	08
50	125	15	6	83	0.33333	1500.0000	AA	AA	A6	0F	06
148.5	74.25	5	10	82	0.5	1485.0000	00	00	A5	05	0A
156.25	125	4	5	69	0.44444	1250.0000	8E	E3	8A	04	05

2.1.3 Executing a Frequency WRITE for (DSC21XX & DSC22XX)

When executing a frequency WRITE to the DSC21XX & DSC22XX devices it is required to place the device in Hibernate by setting (0x10h<5>), execute the frequency WRITE to addresses x13-x17h, then bring the device out of Hibernate by clearing (0x10h<5>). Refer to section 5 for details of entering/exiting Hibernate mode. Allow a 100 μ s delay after applying the Hibernate signal before taking the subsequent Read / Write activity with the device.

The DSC21xx/22xx devices come with pre-stored frequencies selectable by the FSEL pin (pin 14). Frequency-bank 0 registers, selected when FSEL = 0, can be overwritten via I²C/SPI (addresses 0x13 - 0x17). Frequency-bank 1, selected when FSEL = 1, contains fixed frequency information and cannot be modified via I²C/SPI.

FSEL pin (pin 14) can be overwritten by resetting all the eight bits of register 0x12. Resetting register 0x12 makes the device select frequency-bank 0 and therefore allows the I²C/SPI interface to change the output frequency.

2.2 PROGRAMMING CMOS OUTPUT DRIVE STRENGTH & OUTPUT CONTROL MODES

As described earlier, drive strength for CMOS output drivers can be optimized via I²C/SPI interface to help reduce EMI and improve performance. Each CMOS output driver has 8 drive strength settings (3 bits) and can also be independently enabled (logic high) or disabled (logic low) by writing into the corresponding bit, O1E for output 1 and O2E for output 2. An enabled output passes the generated output while a disabled output is in its tri-state condition (high impedance).

Please note that oscillator has to be already enabled via ENABLE pin prior to any serial programming. Please refer to the data sheet of the specific DSC21XX device for the typical rise/fall times for the different output strength settings.

Table 2-5 describes the output control register map. Register bits [7:4] are only applicable to dual output oscillators and can be ignored when programming a single-output oscillator.

TABLE 2-5: REGISTER MAP FOR CMOS OUTPUT DRIVE CONTROL

Register	7	6	5	4	3	2	1	0
0x11	O2S[2]	O2S[1]	O2S[0]	O2E	O1S[2]	O1S[1]	O1S[0]	O1E

2.3 HIBERNATE (LOW CURRENT) MODE

Using serial programming, the DSC21XX or DSC22XX devices can be put into a low current mode to save power. By programming the Hibernate bit (0x10<5>) to a high, the device will enter the low current mode. During Hibernate, all outputs are in the tri-state condition and the PLL and oscillator circuitry are powered down. Less than 100 µA are consumed. Writing a 0 into the Hibernate bit (0x10<5>) will return the device to normal operation.

When writing to register-bit 0x10<5>, care must be taken to not modify the other bits in the register. This can be achieved by masking the other bits with their existing value when writing the hibernate command. The register should be initially read, then rewritten with bit<5> changed to the desired hibernate state while keeping other bits as is.

2.4 I²C BUS CONTROL INTERFACE

The DSC21XX can be configured as a read/write slave device that conforms to Phillips I²C bus specifications except a “general call”. The DSC21XX employs a three pin I²C bus configuration. A Chip Select (Cs_bar) enables I²C communications with DSC21XX. The I²C bus transmits data and clock with SDA and SCL. SDA and SCL are open-drain, that is the device can only drive these lines low or leave them to float. The bus is controlled by a master device that generates the serial clock SCL, controls bus access and generates the START and STOP conditions while the DSC21XX works as a slave. When Cs_bar is low, the accessed device will respond to SDA and SCL. When Cs_bar is high, the accessed device will not respond to I²C signals. The I²C slave interface follows the Philips Fast Mode (400 kHz) format.

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The DSC21XX uses standard I²C data structures and timing sequences. Because the DSC21XX employs a three pin configuration where Cs_bar controls access to the device, any 7 bit slave address can be used in the read or write commands with the exception of all bits equal 0. [Figure 2-1](#) displays the I²C timing diagram and specification.

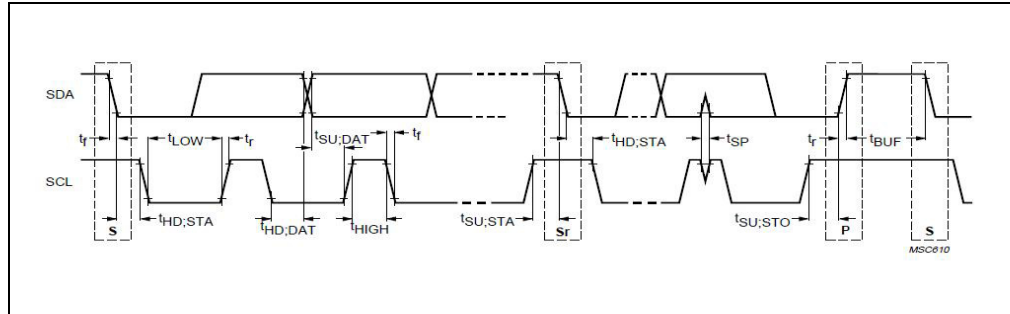


FIGURE 2-1: I²C Timing Diagram.

TABLE 2-6: I²C TIMING SPECIFICATION

Parameter	Symbol	Min	Max	Unit
SCL	t_{SCL}	—	3.4	MHz
SET-UP Start	t_{SU_STA}	160		ns
Hold Time Start	t_{HD_STA}	160		ns
Low period SCK	t_{LOW}	160		ns
High period SCK	t_{HIGH}	160		ns
Data Set-Up Time	t_{SU_DAT}	10		ns
Data Hold Time	t_{HD_DAT}	0	70	ns
Rise Time: SCL	t_{rCL}	10	40	ns
Fall Time: SCL	t_{fCL}	10	40	ns
Rise Time: SDA	t_{rDA}	10	80	ns
Fall Time: SDA	t_{fDA}	10	80	ns
Set-Up Stop	t_{SU_STO}	160	—	ns

The I²C data format to perform read and write is as follows:

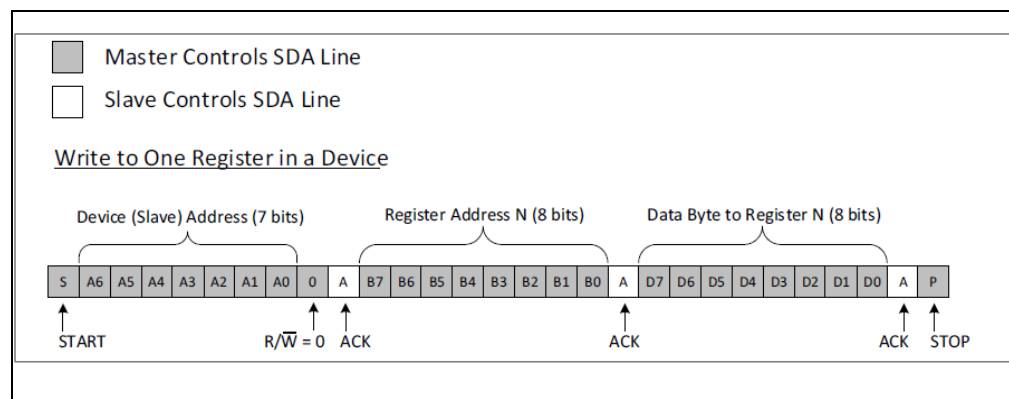


FIGURE 2-2: I²C Write To a (Slave) Register.

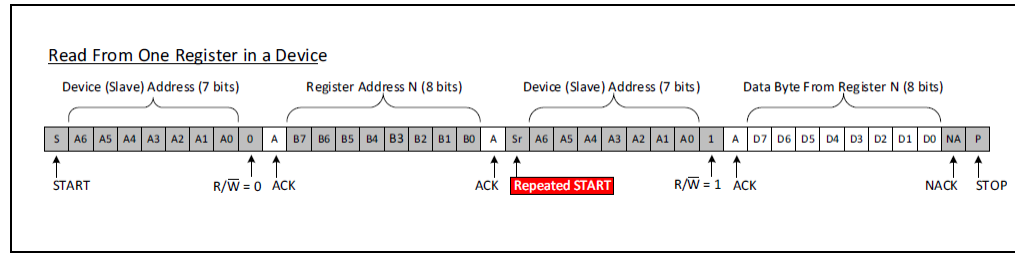


FIGURE 2-3: *I²C Read From a (Slave) Register.*

TABLE 2-7: COMMANDS TO CHANGE OUTPUT FREQUENCY

#	Command	Note/Comment
1	Set CS_low	Very first command to issue that will set CS_low
2	Write 0x0 into register 0x12	Reset register 0x12 to 0 in order to select frequency bank 0
3	Write N value to register 0x15	7 bits only, bits7:1
4	Write F value into register 0x14 and bit0 of register 0x15	MSB of F value goes to bit0 of register 0x15 Next 8 bits go to register 0x14 Least 8 bits (7:0) are automatically truncated
5	Write M1 value into register 0x16	—
6	Write M2 value into register 0x17	—
7	Repeat 3-6 for each desired output frequency	—

2.5 SPI BUS CONTROL INTERFACE

The DSC22XX can be used as a read/write slave device that conforms to SPI bus link protocol. The DSC22XX employs the standard four pin SPI bus configuration. The SS (Chip Select) signal (Active Low) enables communications with DSC22XX. The bus transmits full duplex synchronous data over the MOSI (Master Out Slave In) and MISO (Master In Slave Out) pins. Data is clocked by SCLK. MISO can be tri-stated (high impedance) to permit multiple devices to share the bus.

The DSC22XX uses standard SPI data structures and timing sequences. SPI commands should be preceded by 4 idle/setup cycles with the SS pin held high. This should be followed by asserting SS (taking it low) and transmitting data on the MOSI pin MSB first. The first data consists of a 7-bit register address appended with a read/write selection bit in the LSB position (1=Read, 0=Write).

Figure 2-4 displays the SPI timing diagram and specification.

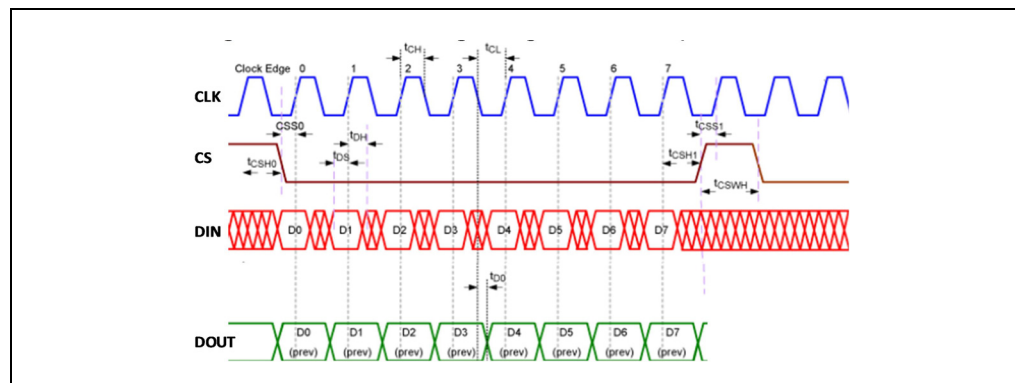


FIGURE 2-4: *SPI Timing Diagram.*

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TABLE 2-8: SPI TIMING SPECIFICATION

Parameter	Symbol	Min	Max	Unit
SCLK	t_{SCL}	—	20	MHz
Low Period SCLK	t_{LOW}	25	—	ns
High Period SCLK	t_{HIGH}	25	—	ns
DIN Set-Up Time	t_{DS}	10	—	ns
DIN Hold Time	t_{DH}	0	—	ns
SCLK Fall to DOUT Valid	t_{DO}	—	22	ns
SCLK High to CS High Hold	t_{CSH1}	22	—	ns
SCLK High to CS Low Hold	t_{CSH0}	0	—	ns
CS Low to SCLK High Setup	t_{CSS0}	10	—	ns
CS High to SCLK High Setup	t_{CSS0}	5	—	ns
CS Pulse Width High	t_{CSS1}	10	—	ns

Figure 2-5 and Figure 2-6 displays example SPI communications.

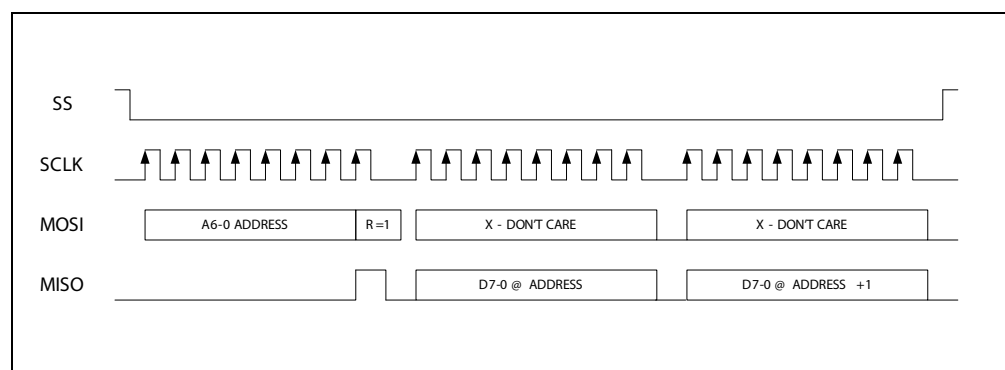


FIGURE 2-5: Example SPI Read Operation.

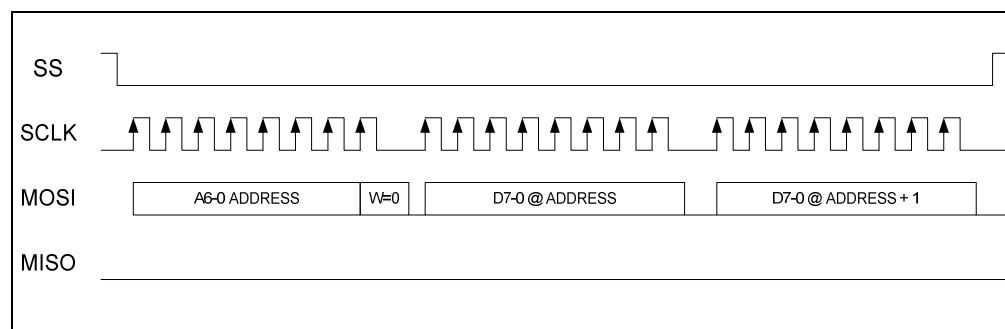


FIGURE 2-6: Example SPI Write Operation.

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